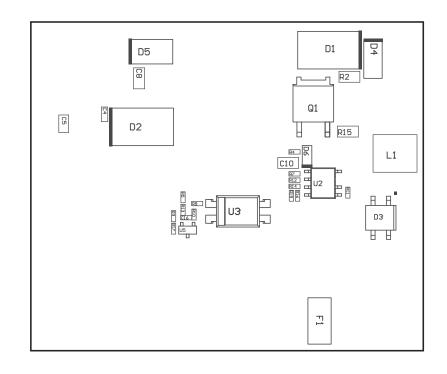


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP9727	REV: A	SUN REU	: Not In VersionControl
IGNORE -> Top Overlay				
PLOT NAME = Top Assembly Drawing	GENERATED : 5/1/20	9:12:17	AM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP9727	REV: A	SUN REU: Not In VersionControl	
	Bottom Overlay <- JACHOI			
PLOT NAME = Bottom Assembly Drawing	GENERATED : 5/1/20	9:12:18	AM	TEXAS INSTRUMENTS

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